

Optimizing Input and Output Transient Settling Times in Amplifier Circuits

Introduction

Operational-amplifier (op amp) circuits often perform system functions where the op amp needs to respond to input and output transients. Some circuits are designed primarily to accept different input transients, such as a sensor signal-conditioning circuit, while others supply output transients, such as an analog-to-digital converter (ADC) input or a reference driver. An often-overlooked aspect in op amp circuit design is the difference in output settling response times for an output (load) step vs. an input step for the same circuit.

In most circuits, the output load connects directly to the output of the op amp; the response time is largely based on the op amp's ability to supply the required load transient and then recover. This behavior depends on the circuit topology, however. In circuits where the op-amp output voltage (V_{opa}) does not directly connect to the load, the output settling response can differ substantially from the input response. A common example of such a circuit, used in situations where the amplifier must drive a capacitive load (C_{load}), is the isolation resistor with dual-feedback (Riso+DFB) circuit topology. The name of the circuit comes from the use of an isolation resistor (R_{iso}) between the V_{opa} and C_{load} nets and the two feedback paths back to the inverting input (IN-) from the feedback capacitor (C_f) and the feedback resistor (R_f).

Figure 1 shows an example Riso+DFB circuit used to drive a capacitive load (C_{load}). The input is directly connected to a voltage source, and therefore the op amp must react to changes that occur on the input. A simple switch (SW1) and resistive load (R_{load}) represent a rudimentary case where the output of the amplifier circuit experiences a load transient to which it must respond.

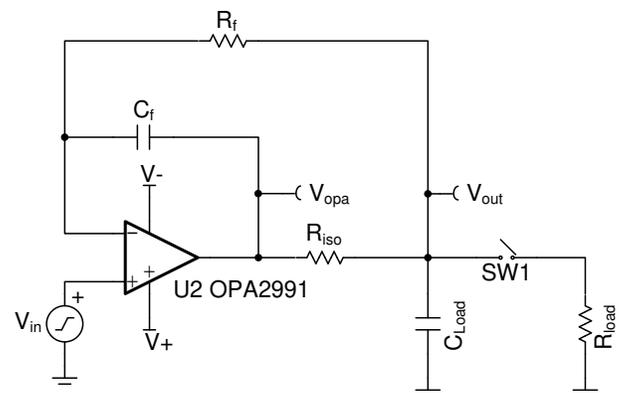


Figure 1. R_{iso} with dual-feedback schematic

The two simulation circuits in **Figure 2** demonstrate the differences in the output response between an input step and a load transient. **Figure 2(a)** applies an input voltage step to the input of the circuit, while **Figure 2(b)** applies a load current step to the output. In the load transient circuit, setting the voltage drop on the output formed from the load current (I_{load}) flowing through R_{iso} ($I_{load} \times R_{iso}$) equal to the input step amplitude sets the initial change in V_{opa} to 10 mV in both circuits, enabling an equal comparison. A 10-mV output step amplitude prevents op-amp large-signal settling behavior, such as slew-rate limitations. In addition, the output current must be small enough to prevent the op amp from going into large-signal short-circuit current limits.

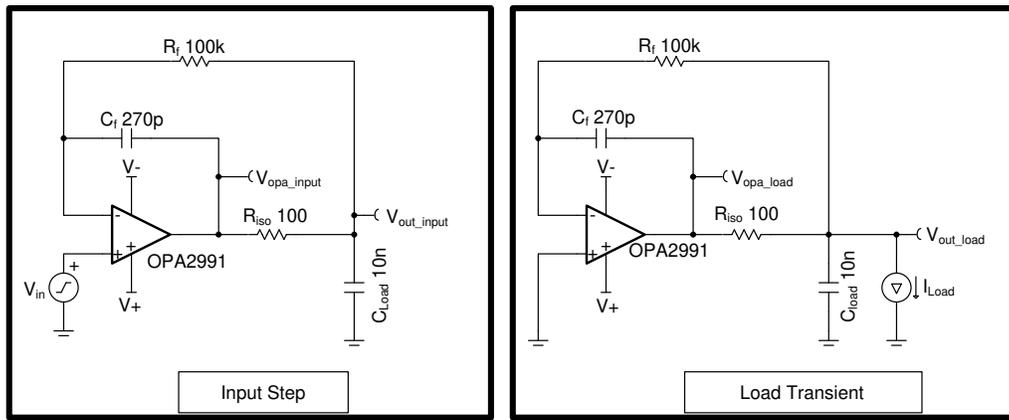


Figure 2. Input step (a) and load transient (b) simulation circuits

Figure 3 shows the results of the two simulation circuits. As designed, the initial change at Vopa is 10 mV for both input and output responses. But the time that it takes for the output voltage at the load (Vout) to settle is different between the two circuits; the input step circuit settles much faster than the output load transient step circuit. For example, to settle to 0.05%, equivalent to 10 bits, it takes 5.02 μs for the input step circuit and 189.42 μs for the output load transient circuit.

Table 1 lists the differences between the input step circuit and load transient step circuit output settling times required for 10- to 18-bit resolution acquisition systems

for the circuit in Figure 2. Testing alternate op amps will result in different settling responses based on the finer effects created from their different output impedances and open-loop gain curves.

Settling Accuracy Level	Input Step Transient Settling Time (μs)	Load Transient Settling Time (μs)
10 bit (0.05%)	5.02	189.42
12 bit (0.01%)	39.94	230.23
14 bit (0.003%)	71.01	261.06
16 bit (0.00076%)	106.45	289.23
18 bit (0.00019%)	142.23	347.08

Table 1. Input and output transient settling times for different settling accuracy levels

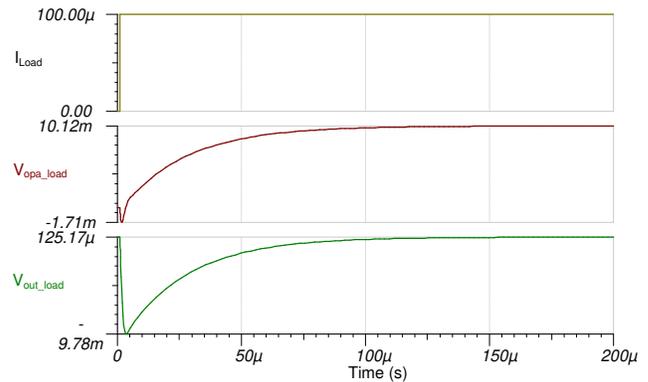
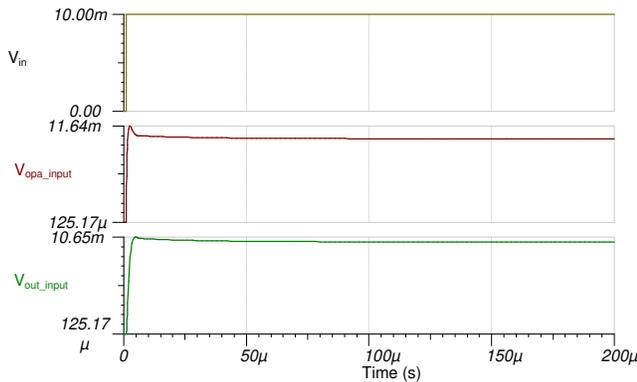


Figure 3. Output settling responses for input step (a) and output load transient (b) circuits

Figure 4 displays the components that dominate the output settling response for an input and output transient, as indicated by the red arrow. For an input step transient, the R_{iso} and C_{load} resistor-capacitor (RC) time constant dominates the output settling time. When the input step occurs, V_{opa} immediately responds to the input voltage step. As the op-amp output voltage rises, V_{out} sees a delay because of R_{iso} and C_{load} .

For a load transient, the R_f and C_f RC time constant dominates the output settling response. When a load transient occurs, V_{out} immediately drops by 10 mV ($R_{iso} \times I_{load}$). The time it takes for V_{opa} to respond to the drop in V_{out} is based on the RC time delay created by R_f and C_f .

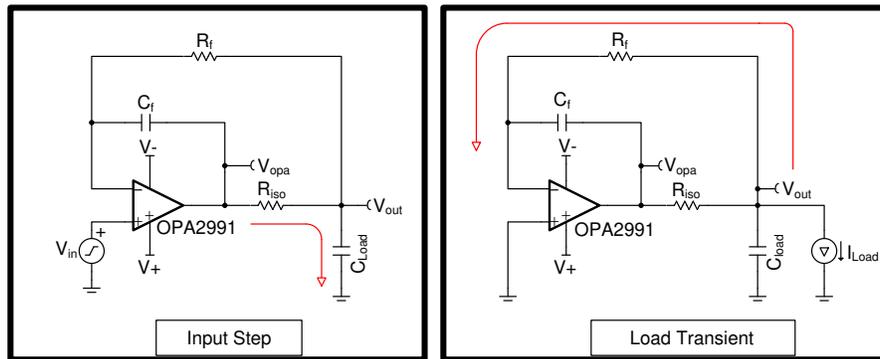


Figure 4. The dominate RC time constant for input step (a) and output load (b) transients

Figure 5 compares the input step and load transient output settling time (bottom responses) with the dominant RC time constants (top responses) described previously. **Figure 5F(a)** compares the input step settling time of V_{out} to an RC circuit response with a 100- Ω resistor and 10-nF capacitor (R_{iso} and C_{load}). **Figure**

5(b) compares the output transient settling time to an RC circuit response with a 100-k Ω resistor and 270-pF capacitor (R_f and C_f). The RC circuit rise times match the input step and load transient output settling response, confirming the theory.

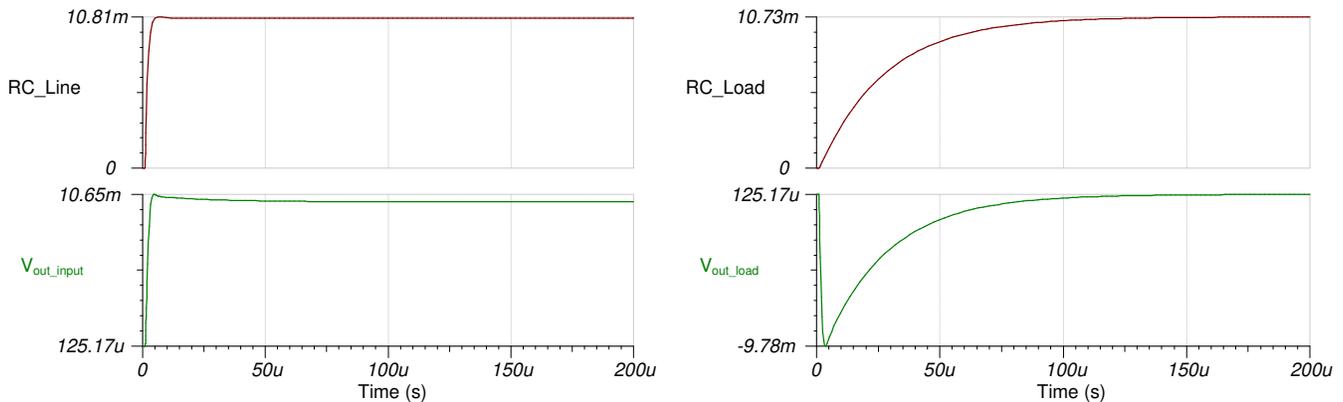


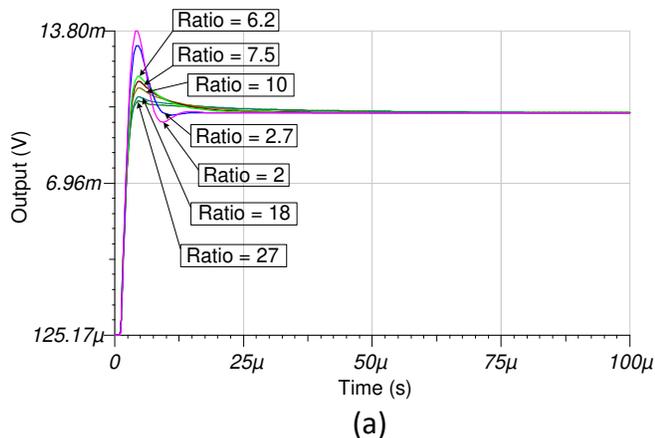
Figure 5. Input step (a) and output load (b) transient settling times, with dominate RC time constants

The stability criteria for the $R_{i_{iso}}$ +DFB circuit is discussed and explains how to optimize the feedback ratios for better load transient settling times. First, the op amp must be stable driving the $R_{i_{iso}}$ + C_{load} combination as a unity-gain buffer. Second, the $1/\text{Beta}$ pole formed by R_f and C_f must be at least less than half the frequency of the zero from $R_{i_{iso}}$ and C_{load} .

- Phase margin of unity-gain buffer driving $R_{i_{iso}} \times C_{load}$: $>45^\circ$
- Feedback ratio: $(R_f \times C_f)/(R_{i_{iso}} \times C_{load}) > 2$

For a greater explanation of the stability theory, see the [TI Precision Labs Videos on Op Amp Stability](#).

While the minimum ratio of the feedback paths for stable operation is 2, there is not a maximum ratio for a stable circuit. Feedback-path ratios of 10, 100 or even 1,000 will also be stable with similar phase-margin results, provided that you meet the first criterion. However,



as shown in **Figure 5**, the output load response is based on the time constant formed from the R_f and C_f components. Therefore, while stable, larger ratios will suffer from load responses that are much slower than the input response.

Figure 6 displays how the output settling response changes by altering the ratio of $(R_f \times C_f)/(R_{i_{iso}} \times C_{load})$. When the feedback ratio is close to the minimum criterion of 2, the output responses for an input step and output load transient are nearly equivalent at the expense of some increasing overshoot and ringing. Increasing the ratio of $(R_f \times C_f)/(R_{i_{iso}} \times C_{load})$ produces a more damped output that begins to have minimal impact for the input step response once the ratio is >20 . Larger ratios continue increasing the load transient output response time, however, because of the ratio's dominance on the $R_f \times C_f$ time constant.

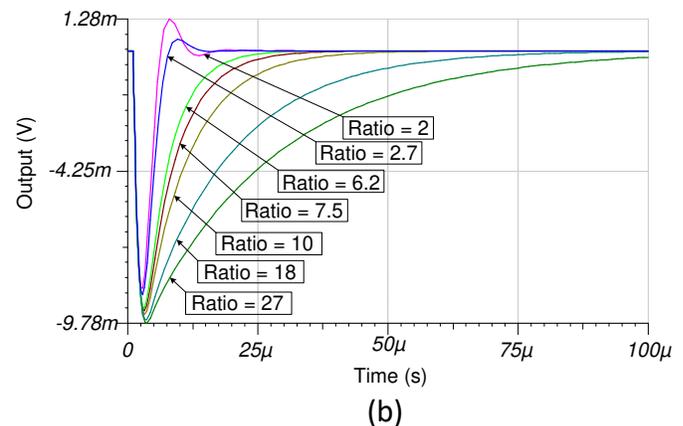


Figure 6. Output settling response for multiple ratios for input step (top) and output load (bottom) transients

Therefore, for the best performance when responding to output load transients, you should design this circuit with a ratio of $(R_f \times C_f)/(R_{iso} \times C_{load})$ close to 2. More conservative design approaches set this ratio between 4 and 10, knowing that interactions between the op-amp characteristics and circuit components and variations

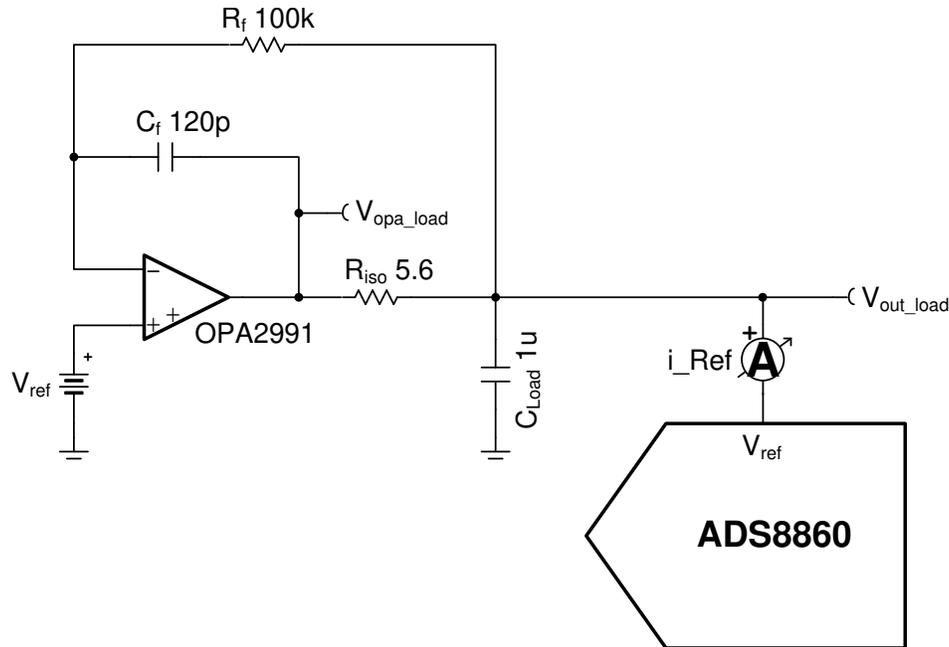


Figure 7. ADC reference drive circuitry

During the conversion phases of the ADC, the successive approximation process includes switching internal capacitor digital-to-analog converter (CDAC) banks into the circuit. Each time a new capacitor switches into the circuit, a burst of current required from the external drive circuit will appear as a load transient. As a result, the Riso+DFB circuit may not properly settle to the load responses without proper configuration of the circuit feedback ratio.

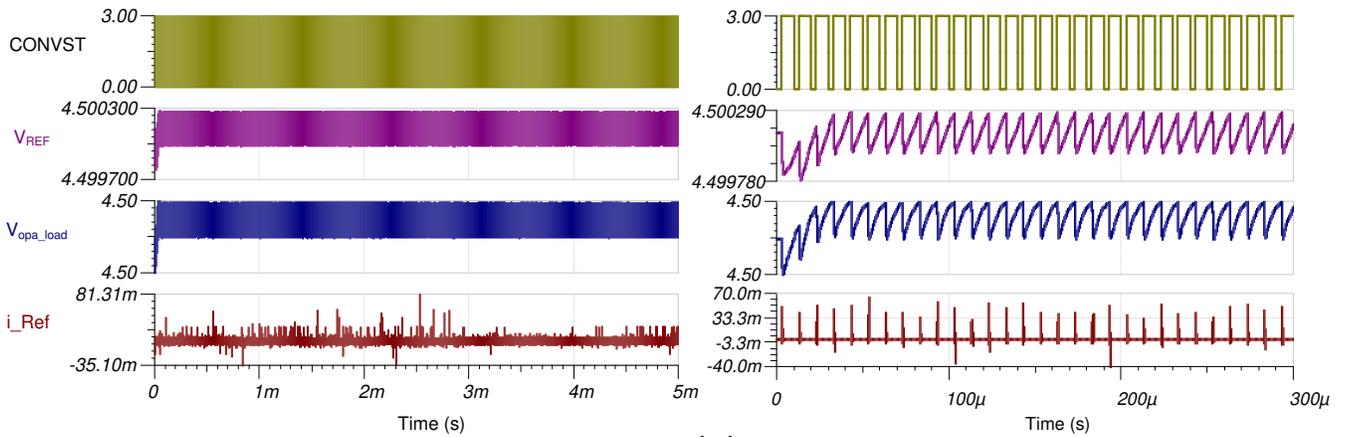
Figure 8 shows these effects in the circuit simulations, using the op-amp circuit in **Figure 7** as the reference buffer for the ADS8860, a 16-bit successive approximation register ADC configured to sample at 100 kSPS in this example. Varying the feedback path ratio in the circuit from values of roughly 3.6 to 360 displays the differences in load settling time. As expected from the results in **Figure 5**, the circuits with higher ratios take

will result in some combinations lower than the targeted ratio. A ratio of the feedback components that falls below 2 will compromise the circuit's stability.

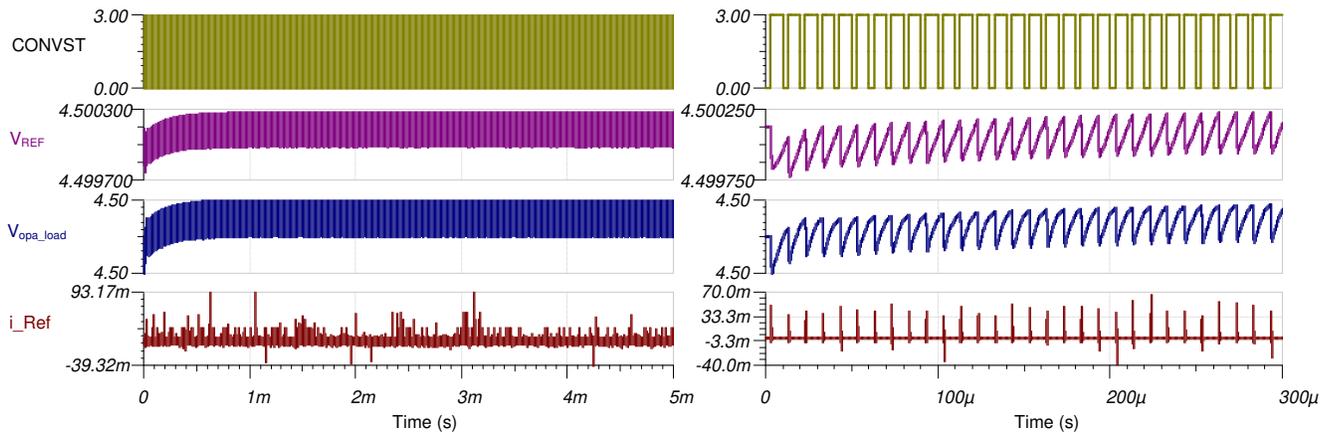
A practical example where this effect comes into play is in ADC reference drive circuitry, as shown in **Figure 7**.

much longer for the reference buffer circuit to reach an equilibrium that results in a least significant bit settling error of $<1/2$ between conversions.

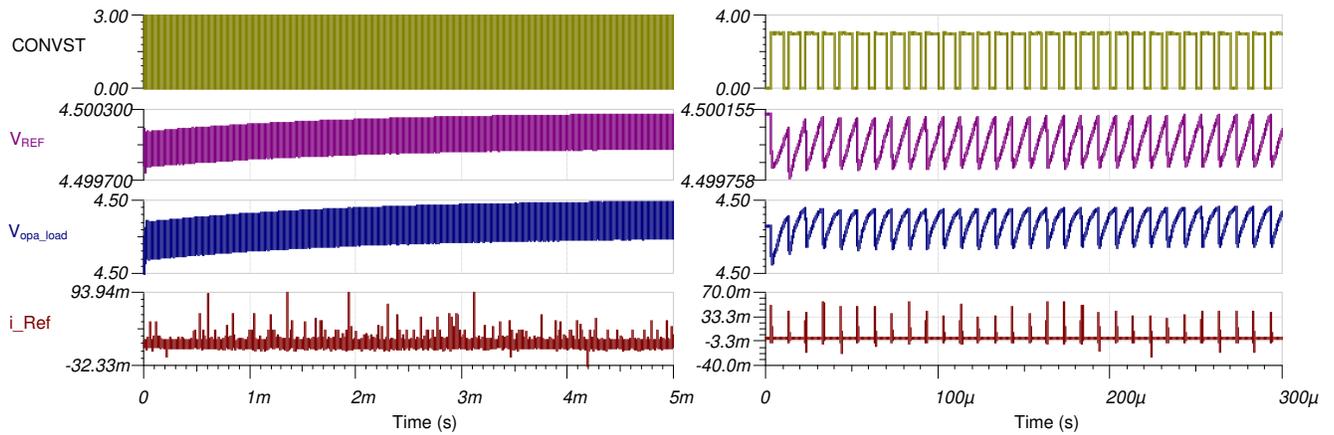
To illustrate this point, the lowest simulated ratio – 3.6 in **Figure 8(a)** – takes about four samples to reach equilibrium, while the results in **Figure 8(c)** with a ratio of 360 take over 400 samples, or about 4 ms, before the circuit reaches equilibrium. Applications commonly take bursts of samples with breaks between, and a circuit with the results shown in **Figure 8(c)** may never fully reach equilibrium before the burst of samples finishes. The unsettled reference can result in conversion errors and AC performance degradation. Recall that the phase margins and input responses of the circuits with ratios of 3.6 and 360 are nearly identical; unexpected circuit results may arise if you don't design the circuit properly and verify the output load response.



(a)



(b)



(c)

Figure 8. ADC reference drive settling with different feedback ratios: 3.6 (a); 36 (b); and 360 (c). The left- and right-hand graphs show 5-ms time scales and 300- μ s time scales, respectively, of the same results.

Conclusion

Applications including ADC input and ADC reference voltage drivers require the op-amp circuit to respond to both output load and input step transients. The $R_{i_{iso}}+DFB$ circuit topology often used in these applications can have large differences in the output settling response times between output and input steps, depending on the selected circuit values and ratios. If you only perform circuit analysis using input steps when designing these circuits, unexpected results for output load settling may negatively impact the application. Therefore, when designing circuits that must respond to both input step transients and output load transients, it is good practice to verify that the settling response to both transient types meets the circuit settling requirements.

Additional Resources

- Collin Wells, “[Transient Stability Testing: Watch Your Step](#)” Planet Analog, Aug. 16, 2013.
- [TI Precision Labs – Op Amps](#)
- [TI Precision Labs – Op Amps: Stability](#)
- [TI Precision Labs – Data Converters](#)

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